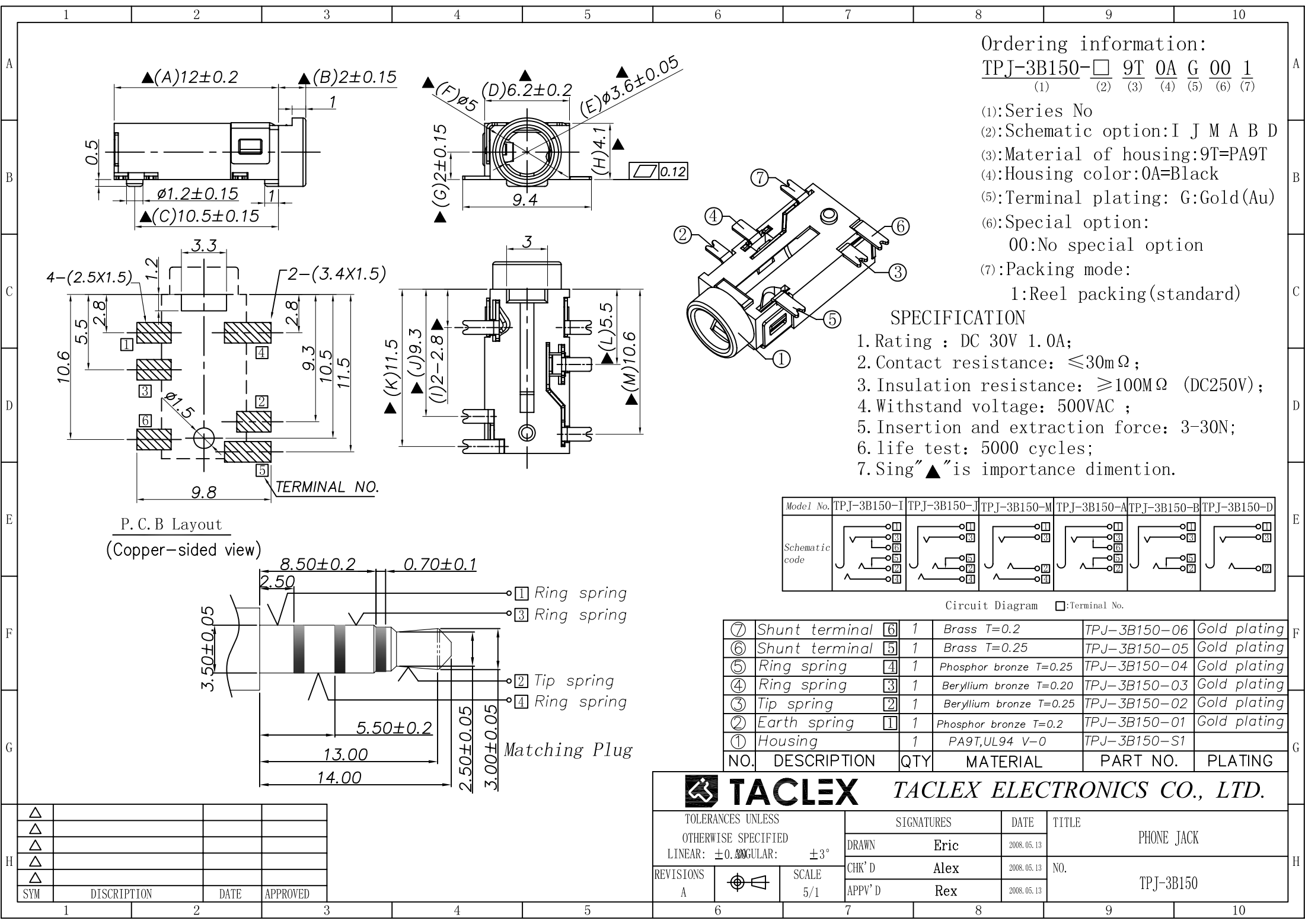




Ordering information:
TPJ-3B150-□ 9T 0A G 00 1
(1) (2) (3) (4) (5) (6) (7)

(1):Series No
(2):Schematic option:I J M A B D
(3):Material of housing:9T=PA9T
(4):Housing color:0A=Black
(5):Terminal plating: G:Gold(Au)
(6):Special option:
00:No special option
(7):Packing mode:
1:Reel packing(standard)

SPECIFICATION

- 1.Rating : DC 30V 1.0A;
- 2.Contact resistance: $\leq 30m\Omega$;
- 3.Insulation resistance: $\geq 100M\Omega$ (DC250V);
- 4.Withstand voltage: 500VAC ;
- 5.Insertion and extraction force: 3-30N;
- 6.life test: 5000 cycles;
- 7.Sing"▲"is importance dimention.

Model No.	TPJ-3B150-I	TPJ-3B150-J	TPJ-3B150-M	TPJ-3B150-A	TPJ-3B150-B	TPJ-3B150-D
Schematic code						

Circuit Diagram □:Terminal No.

⑦	Shunt terminal	⑥	1	Brass T=0.2	TPJ-3B150-06	Gold plating
⑥	Shunt terminal	⑤	1	Brass T=0.25	TPJ-3B150-05	Gold plating
⑤	Ring spring	④	1	Phosphor bronze T=0.25	TPJ-3B150-04	Gold plating
④	Ring spring	③	1	Beryllium bronze T=0.20	TPJ-3B150-03	Gold plating
③	Tip spring	②	1	Beryllium bronze T=0.25	TPJ-3B150-02	Gold plating
②	Earth spring	①	1	Phosphor bronze T=0.2	TPJ-3B150-01	Gold plating
①	Housing		1	PA9T,UL94 V-0	TPJ-3B150-S1	
NO.	DESCRIPTION	QTY		MATERIAL	PART NO.	PLATING



TACLEX

TACLEX ELECTRONICS CO., LTD.

TOLERANCES UNLESS OTHERWISE SPECIFIED
LINEAR: ± 0.00 ANGULAR: $\pm 3^\circ$

SIGNATURES

DATE

TITLE

PHONE JACK

REVISIONS
A



SCALE
5/1

CHK'D
APPV'D

Eric
Alex
Rex

2008.05.13
2008.05.13
2008.05.13

NO.

TPJ-3B150

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SYM	DISCRIPTION	DATE	APPROVED